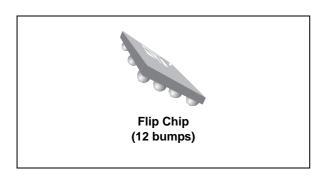


EMIF05-AUD02F3

EMI filter and ESD protection for audio interface

Datasheet - production data



Features

- EMI low-pass filter
- · High efficiency in EMI/ESD protection
- · High reliability offered by monolithic integration
- Very thin package
- High reduction of parasitic elements through integration and wafer level packaging
- Lead-free package

Complies with the following standards:

- IEC 61000-4-2 level 4 (on B1, B2, B3, C1, C3 pins):
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)
- IEC 61000-4-2 level 1 (on A1, A2, A3, D1, D2, D3 pins):
 - ±2 kV (air discharge)
 - ±2 kV (contact discharge)

Applications

Where EMI filtering in ESD sensitive equipment is required:

- · Mobile phones and communication systems
- · Computers, printers and MCU boards.

TM: IPAD is a trademark of STMicroelectronics

Description

The EMIF05-AUD02F3 chip is a highly integrated audio filter device designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interference.

This filter includes ESD protection circuitry, which prevents damage to the protected device when subjected to ESD surges up to 15 kV.

Figure 1. Pin configuration (bump view)

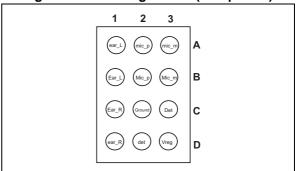
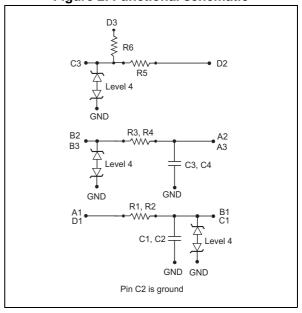


Figure 2. Functional schematic



Characteristics EMIF05-AUD02F3

1 Characteristics

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Symbol	Parameter	Value	Unit
V _{PP}	External pins (B1, B2, B3, C1, C3): ESD discharge IEC 61000-4-2, level 4 Air discharge Contact discharge Internal pins (A1, A2, A3, D1, D2, D3): ESD discharge IEC 61000-4-2 ⁽¹⁾ , level 1 Air discharge Contact discharge	15 8 2 2	kV
T _{op}	Operating temperature range	- 40 to + 85	°C
T _{stg}	Storage temperature range	- 55 to 150	C

Measurements done on IEC 61000-4-2 test bench. For further details see Application note AN3353, "IEC 61000-4-2 standard testing".

Figure 3. Electrical characteristics (definitions)

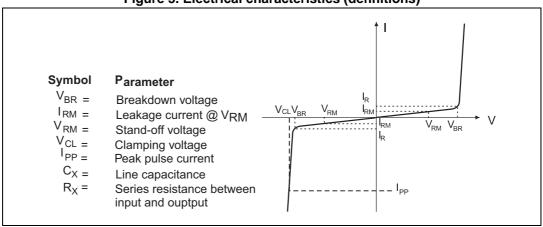


Table 2. Electrical characteristics ($T_{amb} = 25$ °C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
I _{RM}	V _{RM} = 3 V			100	nA
V _{BR}	I _R = 1 mA	6			V
R1, R2		13.5	15	16.5	
R3, R4		1980	2200	2420	0
R5		900	1000	1100	Ω
R6		18000	20000	22000	
C1, C2	V _{line} = 0 V, V _{osc} = 30 mV, F = 1 MHz	3	3.75		nF
C3, C4	(measured under zero light conditions)	0.8	1		ПЕ

EMIF05-AUD02F3 Characteristics

Figure 4. Attenuation versus frequency (MIC lines)

Figure 5. Attenuation versus frequency (Ear lines)

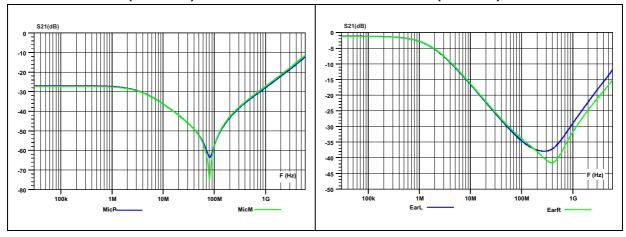
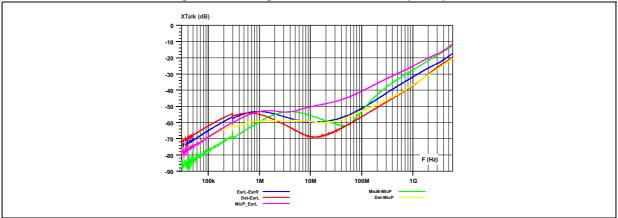


Figure 6. Analog crosstalk versus frequency



Characteristics EMIF05-AUD02F3

5.0 V / Div

OV_: Peak clamping voltage

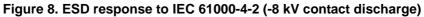
OV_. clamping voltage @ 30 ns

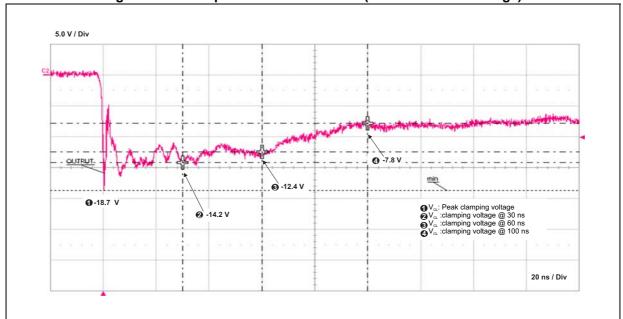
OV_a. clamping voltage @ 100 ns

OUTPUT

OUTPU

Figure 7. ESD response to IEC 61000-4-2 (+8 kV contact discharge)





2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 9. Package dimensions

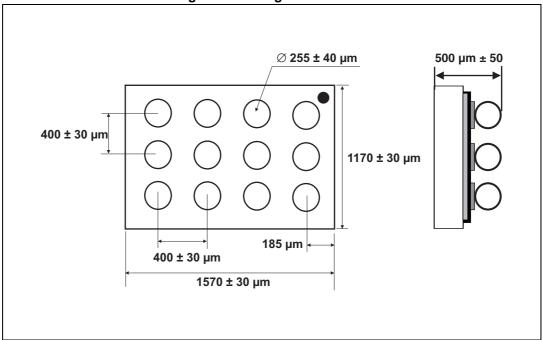
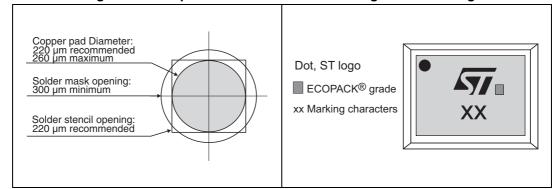


Figure 10. Footprint

Figure 11. Marking



Package information EMIF05-AUD02F3

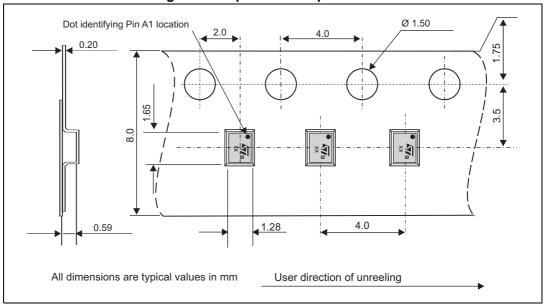


Figure 12. Tape and reel specification



3 Ordering information

Figure 13. Ordering information scheme

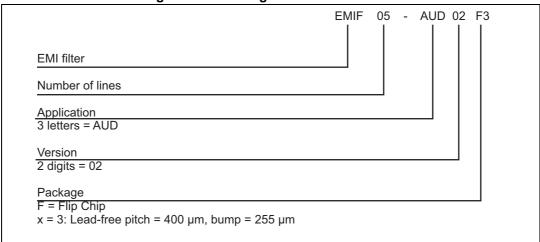


Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF05-AUD02F3	KY	Flip Chip	2.0 mg	5000	Tape and reel 7"

Note: More information is available in the STmicroelectronics Application notes:

AN2348: "Flip Chip: Package description and recommendations for use"

AN1751: "EMI Filters: Recommendations and measurements"

4 Revision history

Table 4. Document revision history

Date	Revision	Changes
12-Dec-2013	1	First issue.

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